

Data Sheet for Product

Part Number : WM72T2F-Y000B-S



The Component corresponds with display's hazardous substance management standard and complies with RoHS and Halogen free.

WOOREE E&L Co.,Ltd.

636-3, Sunggok-dong, Danwon-gu, Ansan-si, Kyunggy-do, Korea. Tel (031)599-3013 Fax (031)494-3174

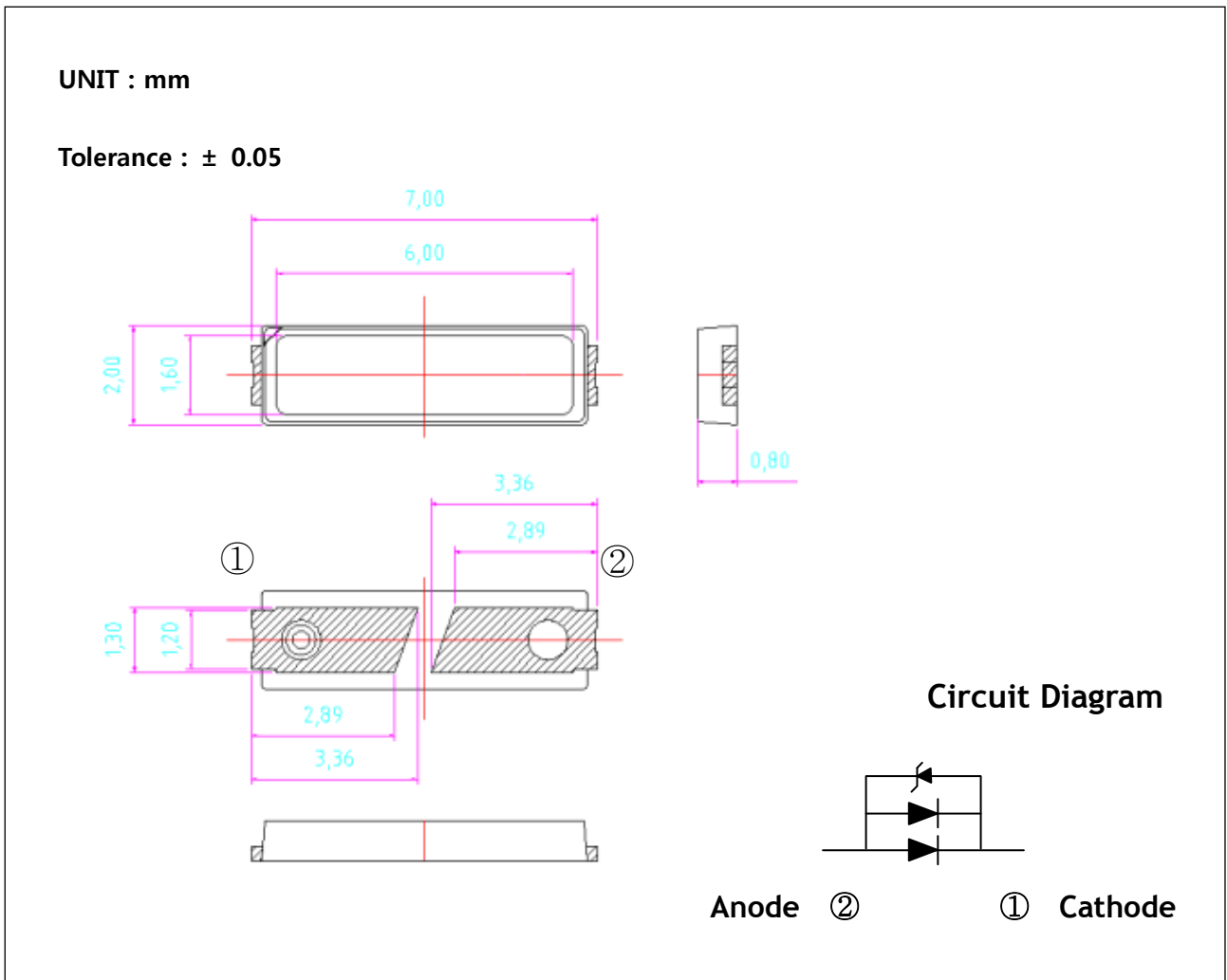
CONTENTS

1. Features
2. Outline Dimension
3. Material Information
4. Absolute Maximum Ratings
5. Electrical / Optical Characteristics
6. Rank Information
7. Characteristic Diagrams
8. Reliability
9. Soldering Information
10. Packaging & Label

1. Features

- SMD Top View Type with Lead Frame Base
- Long Time Reliability
- Package size is 7.0 * 2.0* 0.8t (mm), 2Lead
- Application : TV BLU

2. Outline Dimension



3. Material Information

Item	Chip		Paste		Leadframe		Phosphor	Encap	Wire
	LED	Zener	LED	Zener	Reflector	Metal			
Material	InGaN	Si	Clear Paste	Ag Paste	PCT	Ag plated /Cu	Silicate	Silicone	Au

4. Absolute maximum ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings	Unit
Forward Current	IF	150	mA
Power Dissipation	PD	0.6	W
Reverse Current	IR	50	mA
Pulse Forward Current *1	I _{FP*1}	200	mA
Operating Temperature	Topr	-30 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Solder Temperature	Tsld	Reflow 260 °C,10sec under Hand 340 °C 3sec under	°C
Junction Temperature	Tj	110	°C

*1. Pulse Width ≤ 10msec, Duty ≤ 10%

5. Electrical/Optical characteristics

(Ta=25°C)

Item	Symbol	Condition	Value			Unit	
			Min	Typ	Max		
Luminous Intensity *1	Iv	IF=130mA	12.5	14.4	-	cd	
Forward Voltage *2	VF	IF=130mA	2.9	3.2	3.4	V	
Forward Voltage	VFL	IF=1uA	2.0		2.5		
Forward Voltage	VFL	IF=10uA	2.2	-	2.55	V	
Chromaticity	-	IF=130mA	x	0.255	0.270	0.285	-
Coordinate *3			y	0.222	0.240	0.262	-
Reverse Voltage	VR	IR=-5mA	-0.7		-1.2	V	
Viewing Angle	2Θ1/2	IF=130mA	-	120	-	Deg.	
Thermal Resistance (Junction to Lead)	Rth,j-s	IF=130mA		13		K/W	
Life Time*4	-	Tj max. 80°C	30,000	-	-	hr	
ESD	-	-	5	-	-	KV	
Peak Wavelength	Wp	-	439.5		451.5	nm	

*1. Luminous Intensity(Flux) measurement allowance is ±10%

*2. Forward voltage measurement : ±0.1V

*3. CIE coordinates measurement: ±0.005

*4. Estimated Time to 50% degradation for initial luminous intensity based on WOOREE LED's Internal test results.

※Life time : L50B1 (Min Life time)

6. Ranks

(1) Luminous Intensity

Code	Condition	Min.	Max.	Unit
C5	IF=130mA	12.5	13.0	cd
D0		13.0	13.5	
D5		13.5	14.0	
E0		14.0	14.5	
E5		14.5	15.0	
F0		15.0	15.5	
F5		15.5	16.0	
G0		16.0	16.5	
G5		16.5	17.0	
H0		17.0	17.5	

(2) Forward Voltage

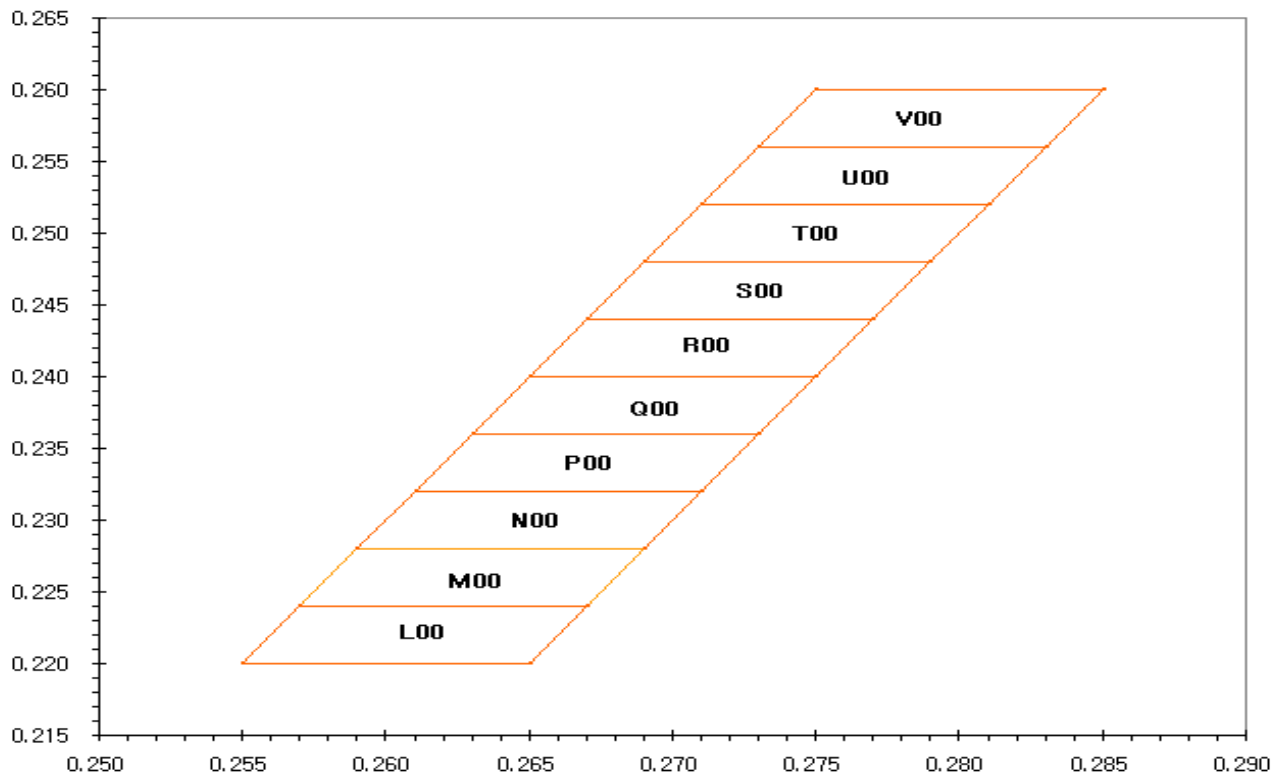
Code	Condition	Min.	Max.	Unit
9	IF = 130mA	2.9	3.1	V
1		3.1	3.3	
3		3.3	3.4	

(3) Peak Wavelength

Code	Condition	Min.	Max.	Unit
A	IF = 130mA	439.5	443.5	nm
B		443.5	447.5	
C		447.5	451.5	

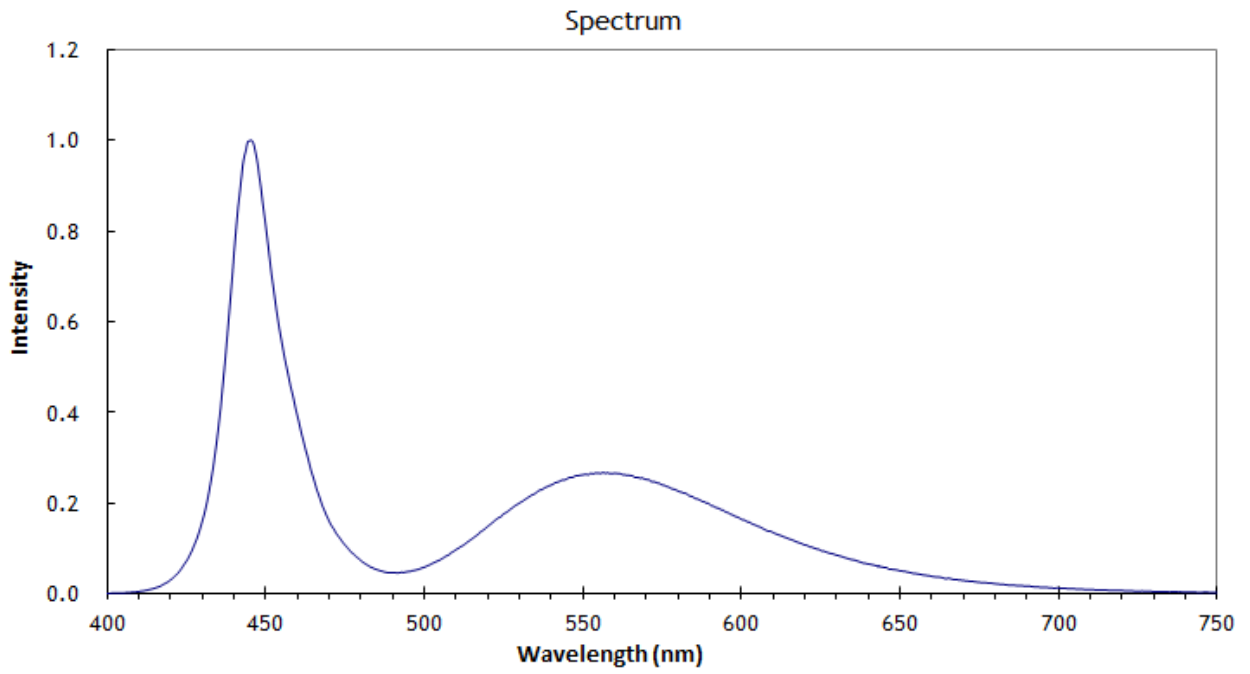
(4) Chromaticity Coordinates Diagram

IF=130mA (Ta = 25°C)



(5) Color spectrum

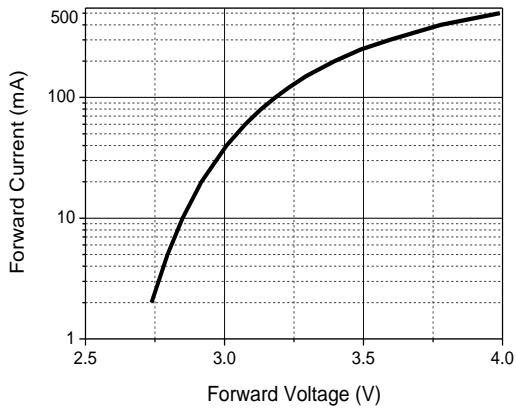
IF=130mA (Ta = 25°C)



7. Characteristic Diagrams

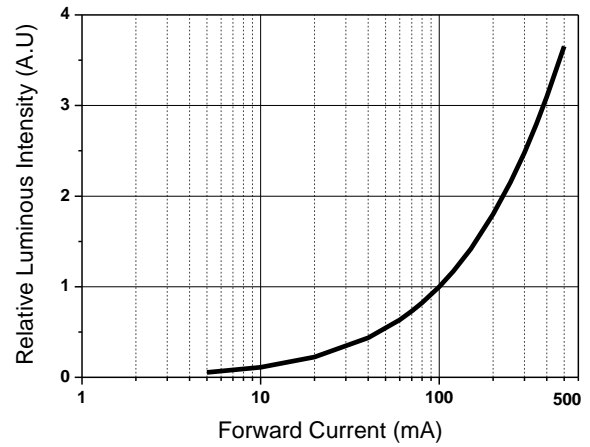
(1) Forward Voltage vs Forward Current

(Ta = 25°C)



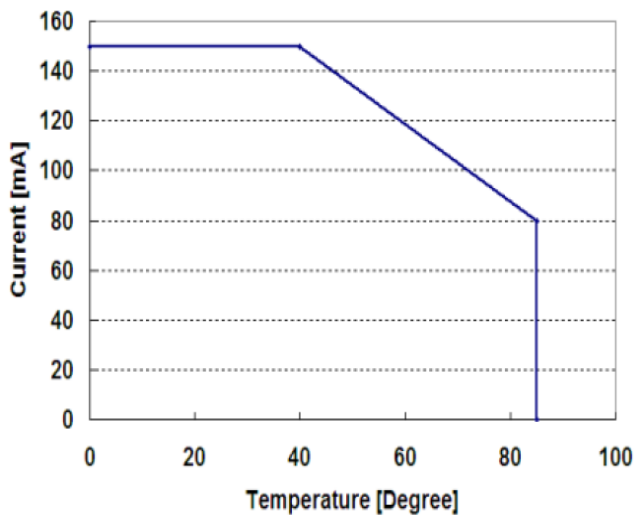
(2) Forward Current vs Relative Luminosity

(Ta = 25°C)



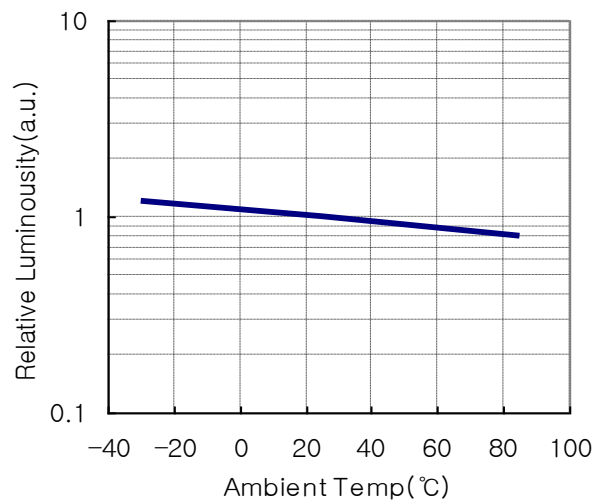
(3) Ambient Temperature vs

Allowable Forward Current



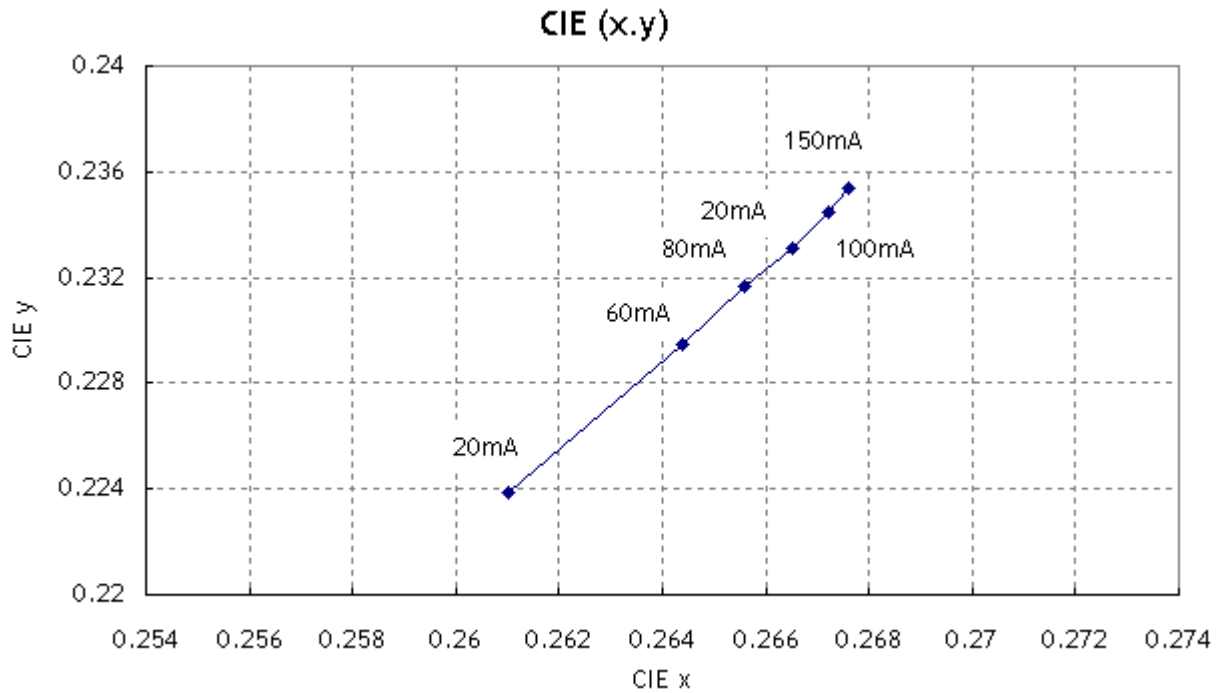
(4) Ambient Temperature vs

Relative Luminous Flux



(5) Forward Current vs Chromaticity coordinate

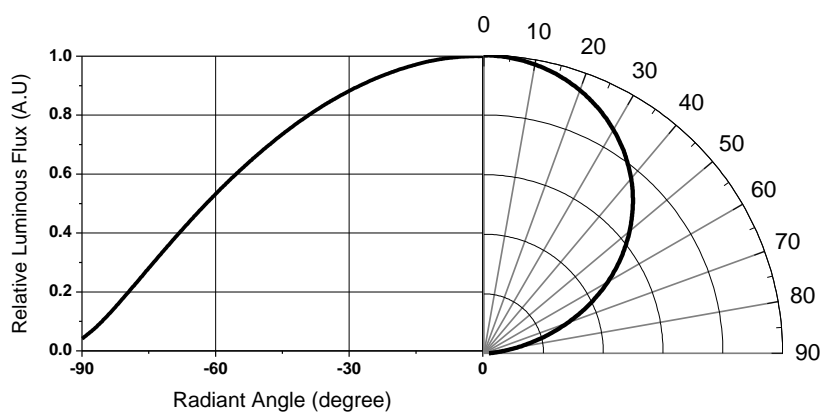
(Ta = 25°C)



(6) View angle profile

IF= 110mA

(Temp: 25°C)



8. Reliability

(1) Test items and results

NO	Test Item	Standard Test Method	Test Conditions	Note	Number of Damaged
1.	Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	Tsld=260°C, 10sec. (Pre treatment 30°C,70%,168hrs)	2 times	0/20
2	Solderability (Reflow Soldering)	JEITA ED-4701 300 303	Tsld=245±5°C, 3sec (Lead Solder)	1 time over 95%	0/20
3	Temperature Cycle	JEITA ED-4701 100 105	-45°C - 125°C 15min – 15min Trans time : 3min	310 cycles	0/20
4	Temperature Cycle	JEITA ED-4701 100 105	-40°C - 100°C 30min - 30min Trans time : 3min	200 cycles	0/20
5	High Temperature Storage	JEITA ED-4701 200 201	Ta=100°C	1000 hrs	0/20
6	Temperature Humidity Storage	JEITA ED-4701 100 103	Ta=85°C, RH=85%	1000 hrs	0/20
7	Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40°C	1000 hrs	0/20

8	Steady State Operating Life	-	Ta=25°C, IF=162.5mA	1000 hrs	0/20
9	Steady State Operating Life of High Temperature	-	Ta=65°C, IF=162.5mA	1000 hrs	0/20
10	Steady State Operating Life of High Temperature	-	Ta=85°C, IF=162.5mA	1000 hrs	0/20
11	Steady State Operating Life of High Humidity Heat	-	Ta=85°C, RH=85%, IF=162.5mA	500 hrs	0/20
12	Steady State Operating Life of Low Temperature	-	Ta=-40°C, IF=162.5mA	1000 hrs	0/20
13	Electro-Static Discharge Threshold	ESD (HBM)	1500Ω, 100pF (Forward/Reverse)	6000V	0/20

(2) Criteria for judging the damage

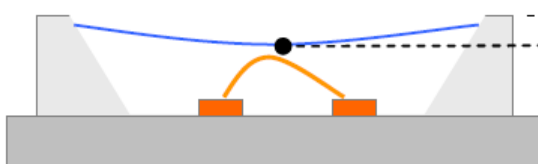
ITEM	Symbol	Test Condition	Criteria for Judgement	
			Min.	Max.
Forward Voltage	VF	IF = 162.5mA	-	U.S.L. *1) × 1.1
Luminous Flux	Φv	IF = 162.5mA	L.S.L.*2) × 0.7	-

*1) U.S.L. : Upper Standard Level

*2) L.S.L. : Lower Standard Level

(3) Silicone Depth Judgement

Silicone Depth Spec

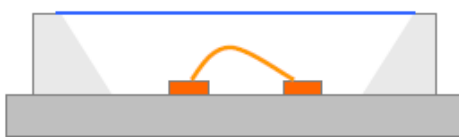


- Silicone Depth = A ~ B
A : Mold 상단면
B : 봉지재 면 (PKG 중심부)

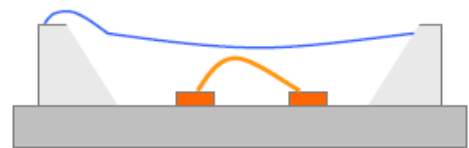
• LED PKG Silicone Depth Spec.

1. 상온 (25°C)에서 Silicone Depth > 30um 일 것
2. Wire는 봉지재 위로 노출 없을 것

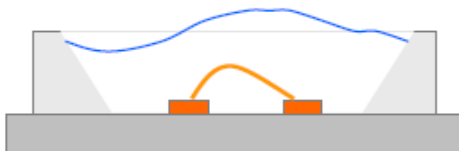
Silicone Depth Spec 불량



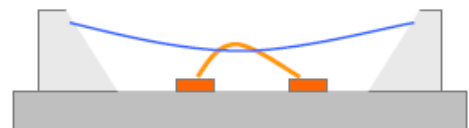
- LED PKG Silicone Depth = 0 um (Flat) 으로 불량 임.



- 봉지재가 Mold 상단면을 넘침으로 불량 임.



- 봉지재의 중심 또는 일부가 Mold 상단면 보다 높출 되므로 불량 임.



- Wire가 봉지재 위로 노출되어 불량 임.

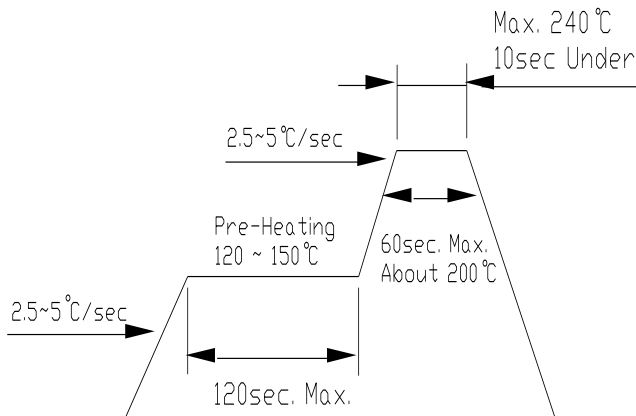
9. Precautions to taken

(1) Recommend soldering conditions

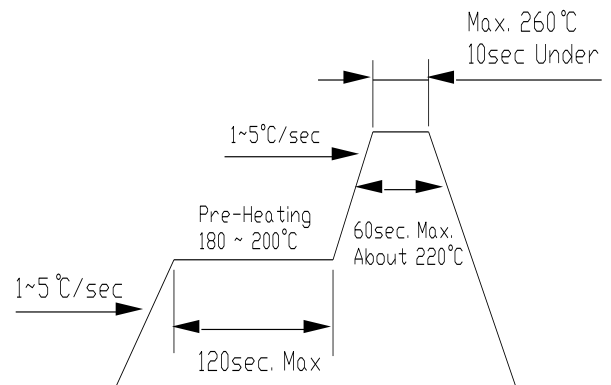
Reflow Soldering			Hand Soldering(Lead Part)	
Pre-heat	Lead Solder	Lead Free Solder	Temperature Soldering Time	Max. 340°C Max. 3sec (only one time)
Pre-heat time				
Peak temperature	120~150°C	180~200°C		
Soldering Time	120sec	120sec. Max.		
Condition	Max. 240°C Max. 10sec	Max. 260°C Max. 10sec		

Temperature-profile

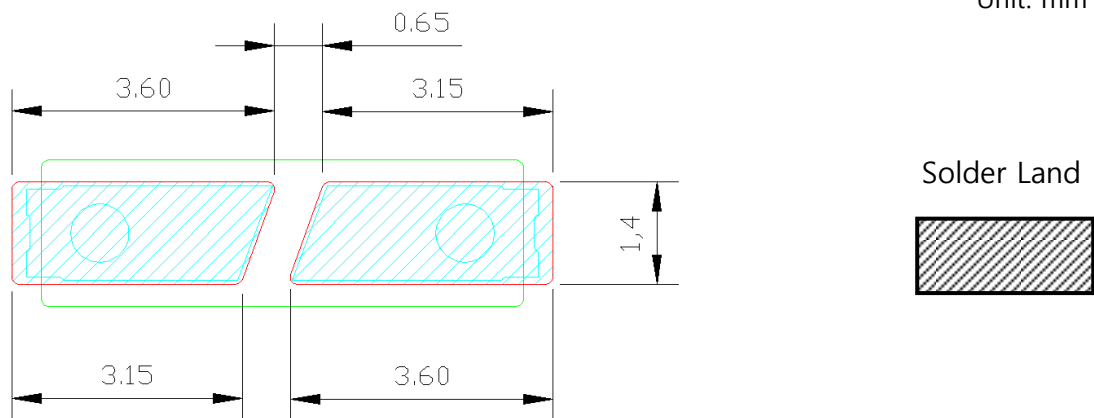
<Lead Solder>



<Lead-free Solder>



<Recommended soldering pad design>



(2) Moisture Proof Package

When moisture is absorbed into the SMT package it may vaporize and expand during soldering. There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture to a minimum in the package. The moisture proof package is made of an aluminum moisture proof bag. A package of a moisture absorbent material (silica gel) is inserted into the aluminum moisture proof bag. The silica gel changes its color from blue to pink as it absorbs moisture.

(3) Storage

[Storage conditions]

Before opening the package

The LEDs should be kept at 30°C or less and 90% RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package

The LEDs should be kept at 30°C or less and 70% RH or less. The LEDs should be

soldered within 168 hours(7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with package of moisture absorbent material(silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

If the moisture absorbent material(silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : more than 24hours at $65\pm 5^{\circ}\text{C}$

WOOREE E&L part's electrodes and leadframes are silver plated copper alloy. The silver surface may be affected by environments which contain corrosive substances.

Please avoid conditions which may cause the LED to corrode, tarnish or discolor. The corrosion or discoloration might lower solderability or might affect on optical Characteristics.

Please avoid rapid transitions in ambient temperature, especially in high humidity environments where condensation can occur.

(4) Heat Generation

Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in the specification.

The operating current should be decided after considering the ambient maximum temperature of LEDs.

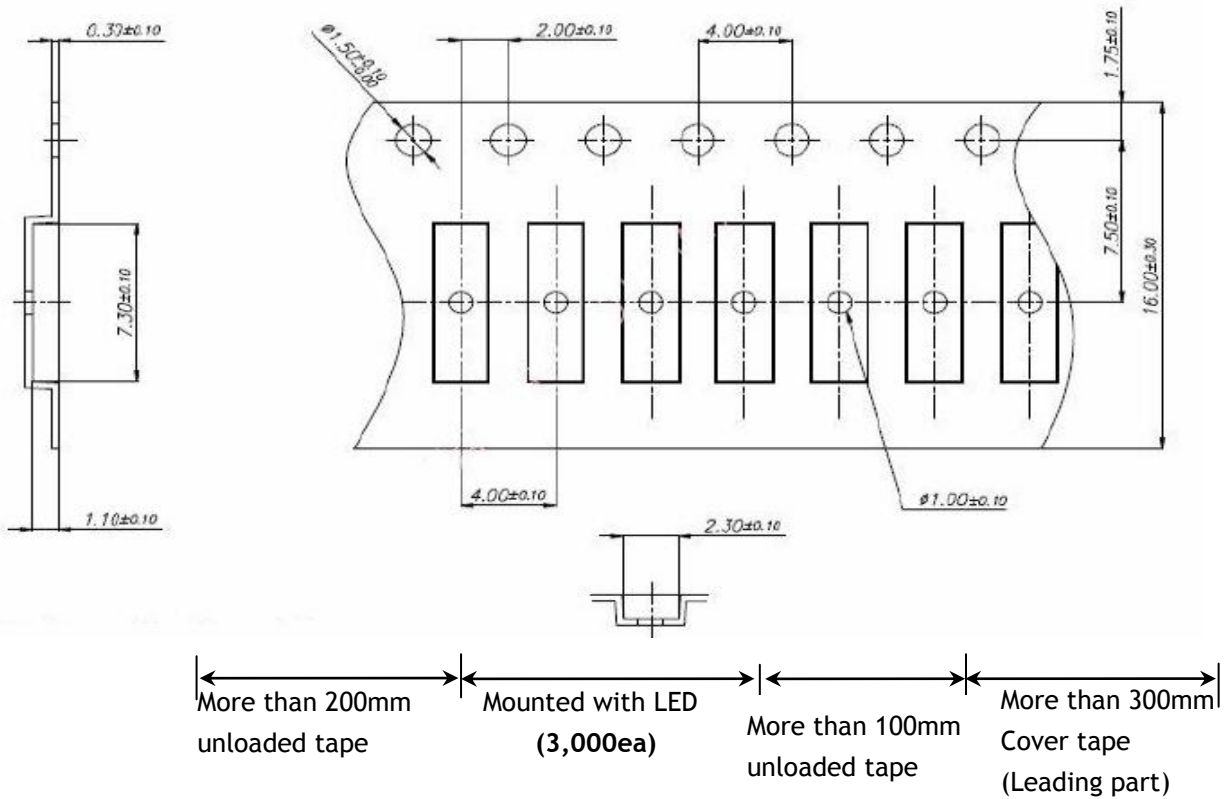
(5) Handling Precautions

When handling the product, touching encapsulant with bare hands will contaminate its surface that could affect optical characteristics. In the worst cases, excessive force to the encapsulant by hand might result in catastrophic failure of the LEDs due to wire deformation and/or breakage.

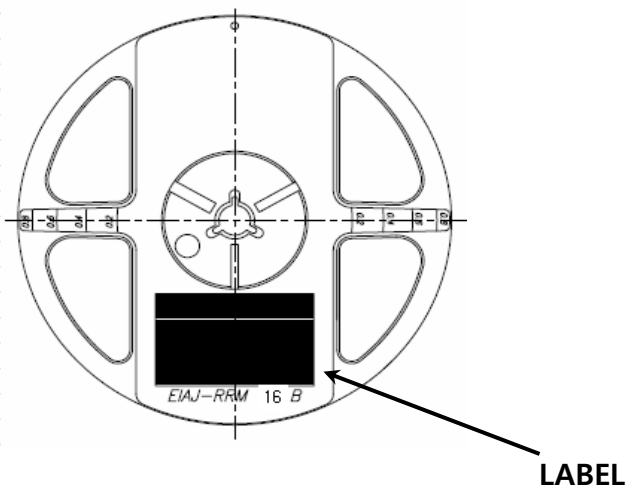
10. Packing & Label

(1) Taping part

unit : mm
tolerance : ± 0.1

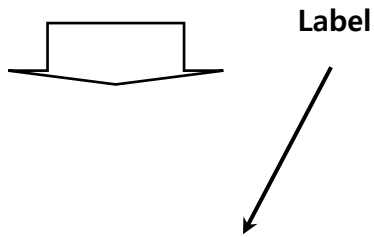
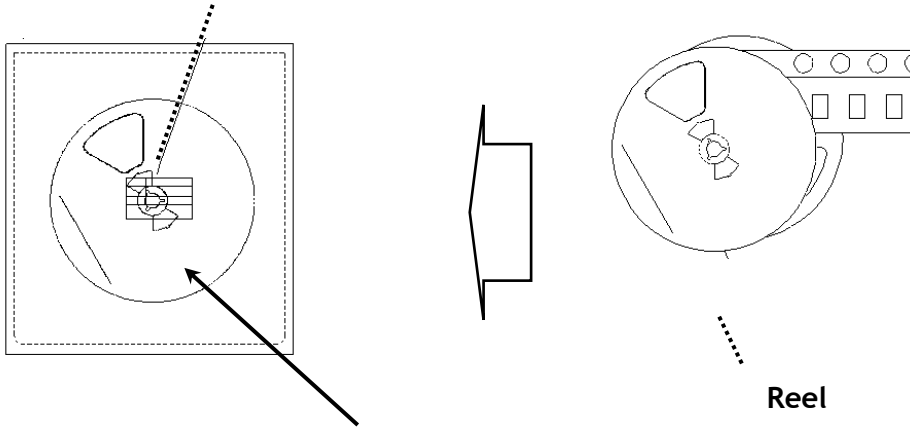


(2) Reel part (Q'ty : 3,000ea/Reel)

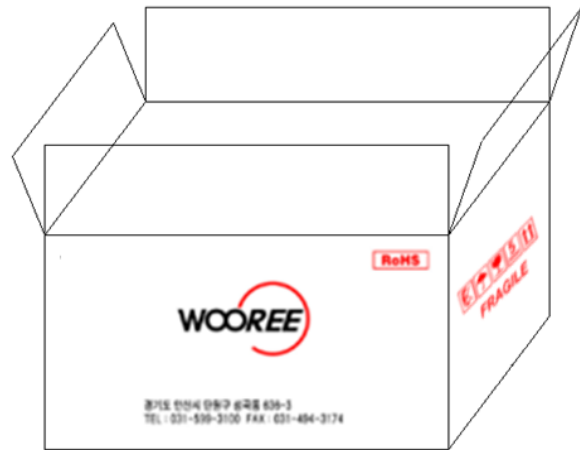


(3) Boxing

Shield Bag (with Silica gel)



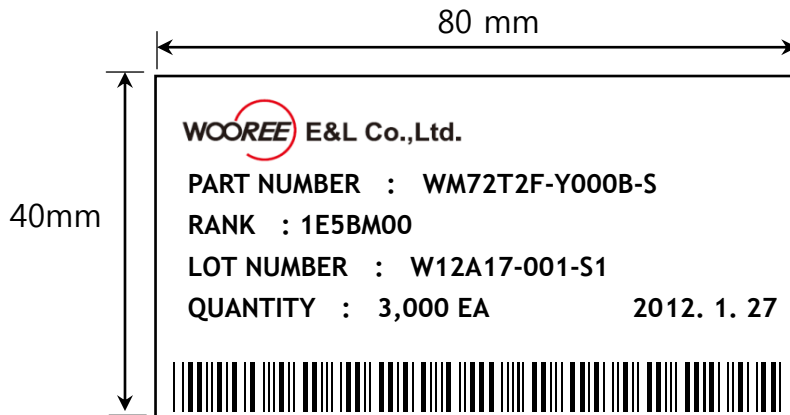
Inner Box



Out box

Box	Dimension (mm)	Reel/Box	Quantity/Box
Inner box	220 x 125 x 261	10 Reel max.	60,000 ea
Out box	383 x 228 x 267	30 Reel max.	90,000 ea

(4) Label Information



(5) Lot Number



① ② ③ ④ ⑤

- ① WOOREE LED Initial
- ② Year (10 for 2010, 11 for 2011)
- ③ Month (A for Jan., B for Feb., ... , N for Dec.)
- ④ Day (01 for 1,....31 for 31)
- ⑤ WOOREE LED Product Running Number

(6) Rank Code description

